

IN THE SPECIFICATION

On page 2, insert before the first line

RELATED APPLICATION

"This application is a Divisional of U.S. Application No. 10/256,899, filed on September 27, 2002, ^{PAT 6,638,851} entitled "Apparatus and Method To Achieve Continuous Interface and Ultrathin Film During Atomic Layer Deposition" which is a Divisional of U.S. Application No.: 09/470,279, filed December 22, 1999, which is now Patent No. 6,503,330, issued January 7, 2003.